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# 1.5A, 600V - 1000V Standard Bridge Rectifier

#### FEATURES

- AEC-Q101 qualified available
- Glass passivated chip junction
- Ideal for automated placement
- Reliable low cost construction utilizing molded plastic technique
- High surge current capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### APPLICATIONS

- Switching mode power supply (SMPS)
- Adapters
- Lighting application

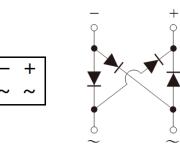
#### **MECHANICAL DATA**

- Case: ABS
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.096g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	1.5	А	
V <sub>RRM</sub>	600 - 1000	V	
I <sub>FSM</sub>	40	А	
T <sub>J MAX</sub>	150	°C	
Package	ABS		
Configuration	Quad		

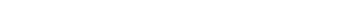






ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER			SYMBOL	ABS15J	ABS15M	UNIT
Marking code on the device			ABS15J	ABS15M		
Repetitive peak reve	erse voltag	е	V <sub>RRM</sub>	600	1000	V
Reverse voltage, tot	al rms valu	Je	V <sub>R(RMS)</sub>	420	700	V
On glass-epoxy		-ероху		1.5		А
Forward current	orward current On aluminum substrate		I <sub>F</sub>	2.0		А
Surge peak forward current single half sinewave superimposed on rated loadt = 8.3mst = 1.0ms		t = 8.3ms		40		А
		t = 1.0ms	FSM	100		А
Rating for fusing (t<8.3ms)		l <sup>2</sup> t	6.64		A <sup>2</sup> s	
Junction temperature		TJ	- 55 to +150		°C	
Storage temperature	;		T <sub>STG</sub>	- 55 to	+150	°C









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THERMAL PERFORMANCE				
PARAMETER	SYMBOL	ТҮР	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	25	°C/W	
Junction-to-ambient thermal resistance	R <sub>eja</sub>	80	°C/W	

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^{\circ}C$ unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage per diode <sup>(1)</sup>	$I_F = 0.5A, T_J = 25^{\circ}C$	V <sub>F</sub>	0.88	-	V
	$I_F = 1.5A, T_J = 25^{\circ}C$		0.97	1.00	V
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	$T_J = 25^{\circ}C$	- I <sub>R</sub>	-	5	μA
Reverse current @ rated v <sub>R</sub> per diode	T <sub>J</sub> = 125°C		-	150	μA

#### Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

#### ORDERING INFORMATION

ORDERING CODE <sup>(1)(2)</sup>	PACKAGE	PACKING	
ABS15x	ABS	5,000 / Tape & Reel	
ABS15xH	ABS	5,000 / Tape & Reel	

Notes:

1. "x" defines voltage from 600V(ABS15J) to 1000V(ABS15M)

2. "H" means AEC-Q101 qualified



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

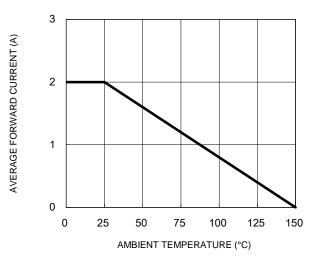


Fig.1 Forward Current Derating Curve

#### **Fig.3 Typical Reverse Characteristics**

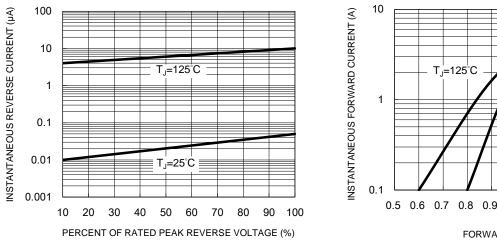
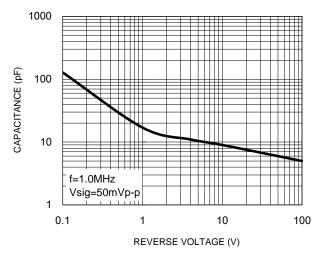
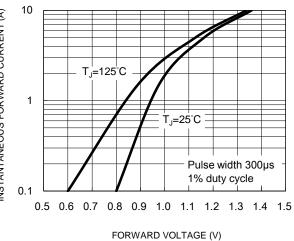


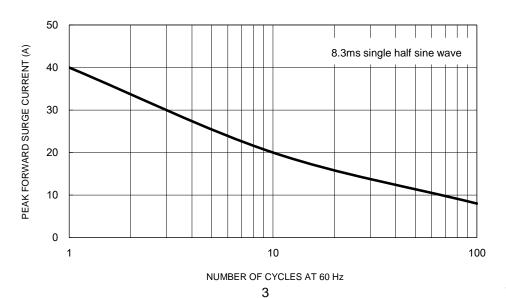
Fig.2 Typical Junction Capacitance



**Fig.4 Typical Forward Characteristics** 

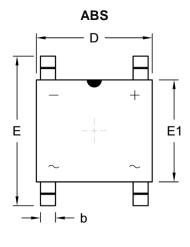


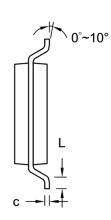




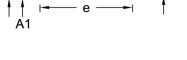


#### **PACKAGE OUTLINE DIMENSIONS**





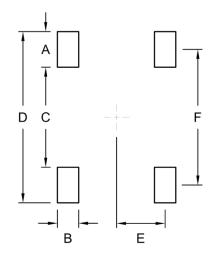
DIM.	Unit (mm)		Unit (	(inch)
	Min.	Max.	Min.	Max.
A	1.40	1.60	0.055	0.063
A1	0.05	0.15	0.002	0.006
A2	1.35	1.45	0.053	0.057
b	0.60	0.70	0.024	0.028
с	0.15	0.25	0.006	0.010
D	4.90	5.10	0.193	0.201
E	6.25	6.65	0.246	0.262
E1	4.30	4.50	0.169	0.177
е	3.90	4.10	0.154	0.161
L	0.30	0.70	0.012	0.028



1

А

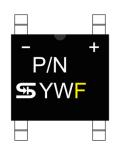
### SUGGESTED PAD LAYOUT



A2

Symbol	Unit (mm)	Unit (inch)
А	1.50	0.059
В	0.90	0.035
С	4.22	0.166
D	7.22	0.284
E	2.05	0.081
F	5.72	0.225

## **MARKING DIAGRAM**



- P/N = Marking Code
- YW = Date Code
- F = Factory Code



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